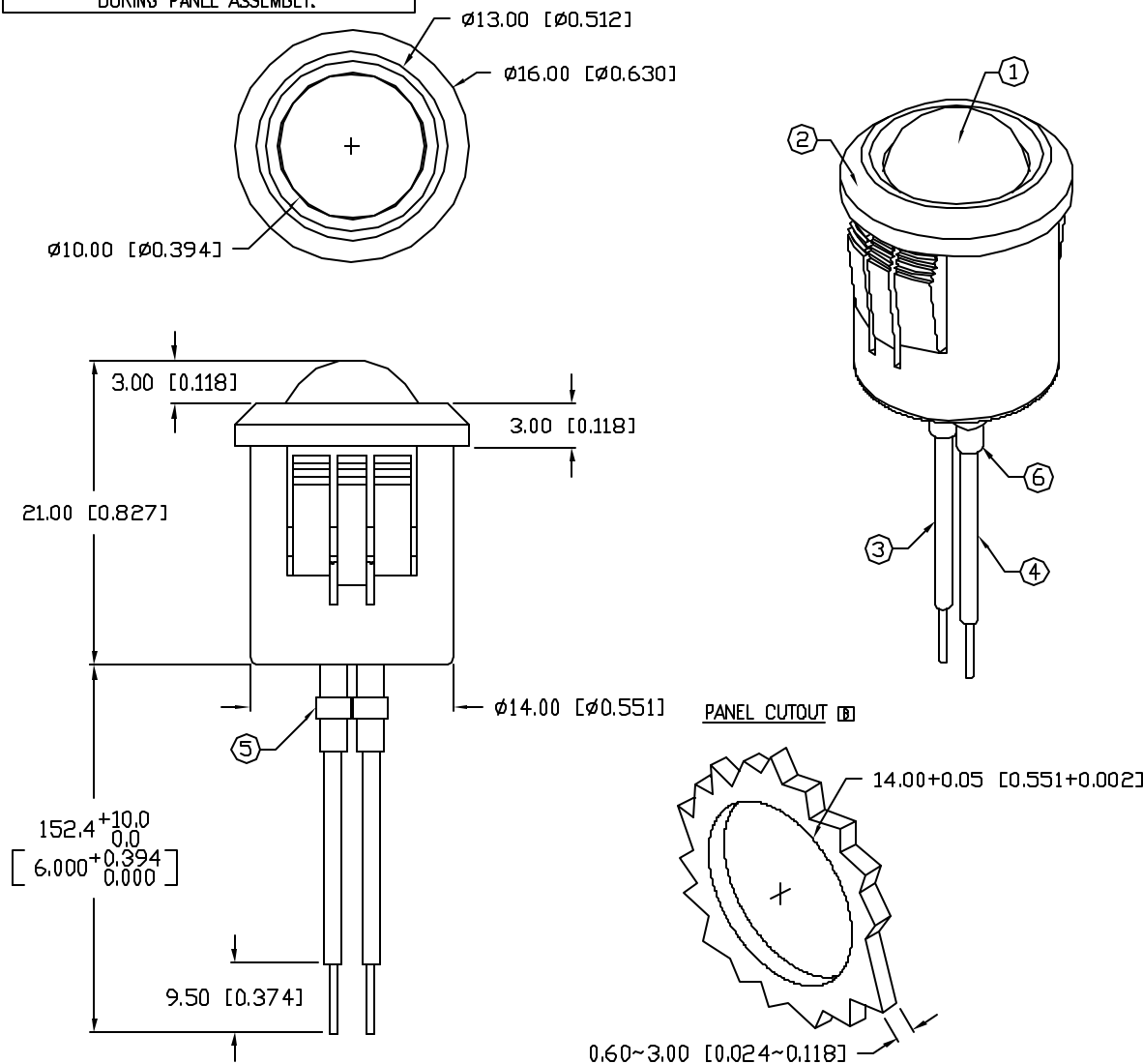


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CAUTION: PRESSURE SENSITIVE ASSEMBLY
AVOID APPLYING PRESSURE TO LED
DURING PANEL ASSEMBLY.



PART NUMBER		REV.
SSI-LXH1090GD-150		C
REV.	E.C.N. NUMBER AND REVISION COMMENTS	DATE
A	E.C.N. #10423.	3.24.98
B	E.C.N. #10539.	9.24.99
C	E.C.N. #10BRDR. & REDRAWN IN 3D.	1.5.02

ELECTRO-OPTICAL CHARACTERISTICS $T_A=25^{\circ}\text{C}$ $I_f=20\text{mA}$

PARAMETER	MIN	TYP	MAX	UNITS	TEST COND
PEAK WAVELENGTH		565		nm	
FORWARD VOLTAGE		2.2	2.6	V_f	
REVERSE VOLTAGE	5.0			V_r	$I_r=100\mu\text{A}$
AXIAL INTENSITY		30		mcad	$I_f=20\text{mA}$
VIEWING ANGLE		60		2x theta	
EMITTED COLOR:	GREEN				
EPOXY LENS FINISH:	GREEN DIFFUSED				

LIMITS OF SAFE OPERATION AT 25°C

PARAMETER	MAX	UNITS
PEAK FORWARD CURRENT*	150	mA
STEADY CURRENT	25	mA
POWER DISSIPATION	105	mW
DERATE FROM 25°C	-1.2	mW/ $^{\circ}\text{C}$
OPERATING, STORAGE TEMP.	-40 TO +85	$^{\circ}\text{C}$

* $t < 10\mu\text{s}$

NOTES:

- SSL-LX100133GD LED.
- SSH-RTF1090 HOLDER.
- ANODE LEAD: LXP-WST24RDT0C, 24 AWG STRANDED, RED INSULATION, CUT 144mm LONG, STRIP 3mm & 9.5mm.
- CATHODE LEAD: LXP-WST24BLT0C, 24 AWG STRANDED, BLACK INSULATION, CUT 144mm LONG, STRIP 3mm & 9.5mm.
- CRIMP WIRE LEADS TO LED LEADS.
- 2 PIECES- 32mm, 1/16" BLACK HEAT SHRINK TUBING.
- UV EPOXY TO RETAIN LED IN HOLDER.

UNCONTROLLED DOCUMENT

*UNLESS OTHERWISE SPECIFIED TOLERANCES PER DECIMAL PRECISION ARE: X=±1 (±0.039), X.X=±0.5 (±0.020), X.XX=±0.25 (±0.010), X.XXX=±0.127 (±0.005). LEAD SIZE=±0.05 (±0.002), LEAD LENGTH=±0.75 (±0.030). MIN.=+0.00/-0.00 MAX.=+0.00/-0.00

REV.	PART NUMBER	CONFIDENTIAL INFORMATION		LUMEX		290 E. HELEN ROAD
C	SSI-LXH1090GD-150	THE INFORMATION CONTAINED IN THIS DOCUMENT IS THE PROPERTY OF LUMEX INC. EXCEPT AS SPECIFICALLY AUTHORIZED IN WRITING BY LUMEX INC., THE HOLDER OF THIS DOCUMENT SHALL KEEP ALL INFORMATION CONTAINED HEREIN CONFIDENTIAL AND SHALL PROTECT SAME IN WHOLE OR IN PART FROM DISCLOSURE AND DISSEMINATION TO ALL THIRD PARTIES.				PALATINE, IL 60067-6976
T-10mm 565nm GREEN LED PANEL INDICATOR, GREEN DIFFUSED LENS, 6" WIRE LEADS.		RELIABILITY NOTE OUR MANY YEARS OF EXPERIENCE DATA ACCUMULATION INDICATE THAT SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE FAILURE. PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS.		DRAWN BY:	CHECKED BY:	APPROVED BY:
				BC		DATE: 6.15.95
						PAGE: 1 OF 1
						SCALE: N/A